

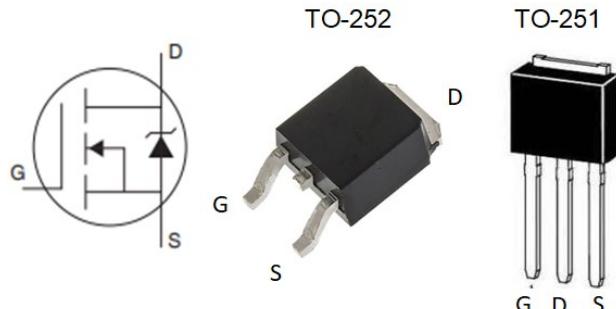
Description

The CM65R550U/D is the N-Channel enhancement mode power field effect transistors with high cell density, high voltage Super Junction technology. This high density process and design have been optimized switching performance and especially tailored to minimize on-state resistance, .

Features

- VDS: 650V
- ID (@VGS=10V): 7.7A
- RDS_{ON} (@VGS=10V) : < 555mΩ
- High density cell design for extremely low RDS_{ON}
- Excellent on-resistance and DC current capability

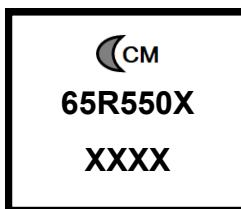
Equivalent Circuit and Pin Configuration



Applications

- AC/DC load switch
- SMPS
- LED power

Marking Information



X=Package type

XXXX = Marking Code

Ordering Information

P/N	Package Type	Packaging
CM65R550U	TO-252	Tape and reel
CM65R550D	TO-251	Tube

Absolute Maximum Ratings (T_c=25 °C unless otherwise noted)

Parameter	Symbol	Maximum		Unit
		CM65R550U	CM65R550D	
Drain-source Voltage	V _{DS}	650		V
Gate-source Voltage	V _G S	±30		V
Continuous Drain Current ⁽¹⁾	I _D	7.7		A
		4.9		A
Pulsed Drain Current ⁽²⁾	I _{DM}	31		A
Total Power Dissipation ⁽³⁾	P _D @ T _c =25°C	89		W
	Derating Factor above 25°C	0.7		W/°C
Thermal Resistance Junction-to-Case ⁽³⁾	R _{θJC}	1.4		°C/W
Junction and Storage Temperature Range	T _{J,TSTG}	-55 to +150		°C

Electrical Characteristics (T_c=25 °C unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Static Parameter						
Drain-Source Breakdown Voltage	BVDSS	V _{GS} =0V, I _D =250μA	650			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =650V, V _{GS} =0V, T _c =25°C			1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±30V, V _{DS} =0V			±100	nA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA	2.0		4.0	V
Static Drain-Source on-Resistance	R _{DS(on)}	V _{GS} =10V, I _D =4A		460	555	mΩ
Diode Forward Voltage	V _{SD}	I _S =8A, V _{GS} =0V			1.4	V
Maximum Body-Diode Continuous Current	I _S				8	A
Dynamic Parameters						
Input Capacitance	C _{iss}	V _{DS} =100V, V _{GS} =0V, f=1MHz		510		pF
Output Capacitance	C _{oss}			26		
Reverse Transfer Capacitance	C _{rss}			2		
Switching Parameters						
Total Gate Charge	Q _g	V _{DS} =480V, I _D =4.0A, V _{GS} =10V		12		nC
Gate Source Charge	Q _{gs}			2.4		
Gate Drain Charge	Q _{gd}			4.4		
Turn-on Delay Time	t _{D(on)}	V _{GS} =10V, V _{DD} =60V, R _L =15Ω, I _D =4A, R _{GEN} =25Ω		36		ns
Turn-on Rise Time	t _r			18		
Turn-off Delay Time	t _{D(off)}			39		
Turn-off Fall Time	t _f			23		

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, t≤ 10 sec.
3. Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2%.
4. Guaranteed by design, not subject to production.

Typical Performance Characteristics

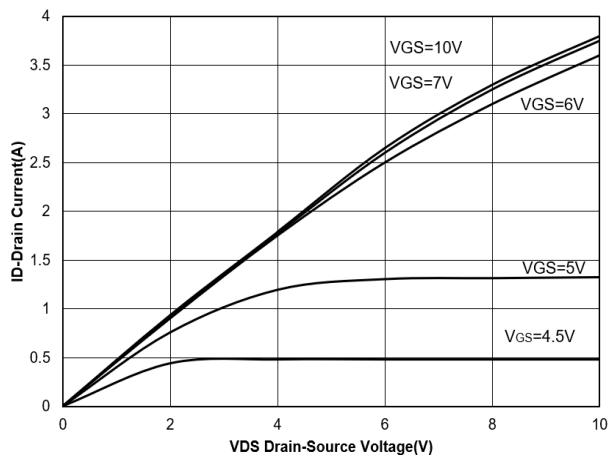


Figure 1. Output Characteristics

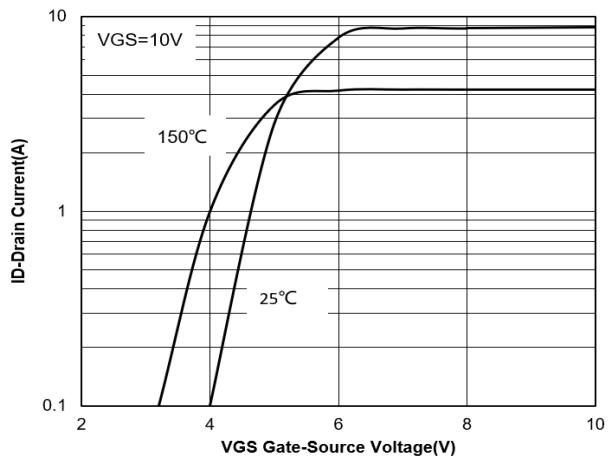


Figure 2. Transfer Characteristics

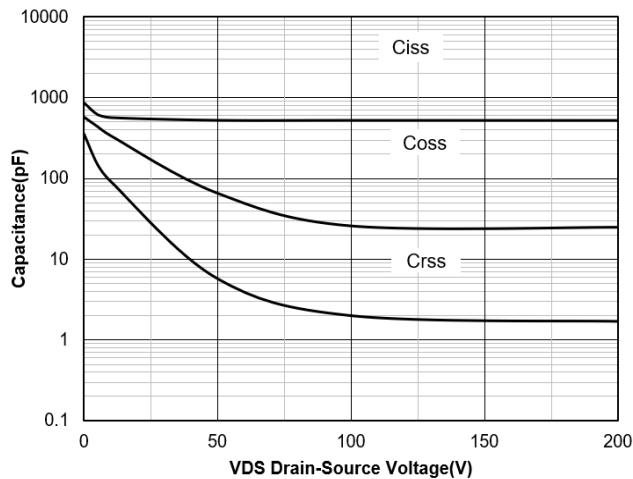


Figure 3. Capacitance Characteristics

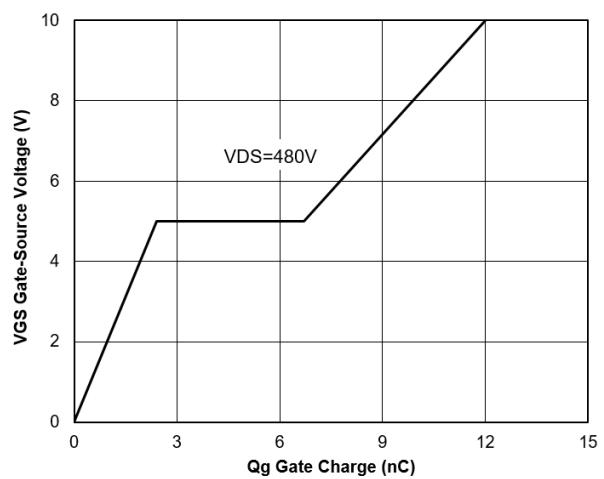


Figure 4. Gate Charge

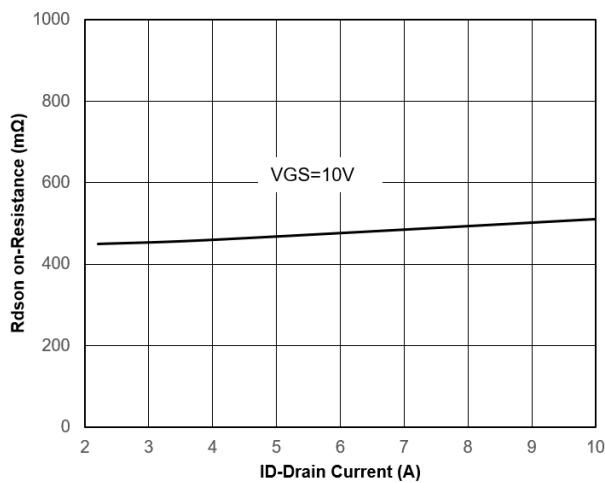


Figure 5. Drain-Source on Resistance

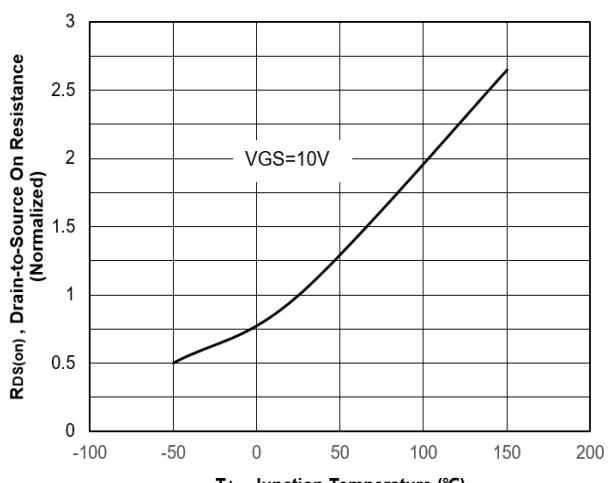


Figure 6. Normalized On-Resistance Vs. Temperature

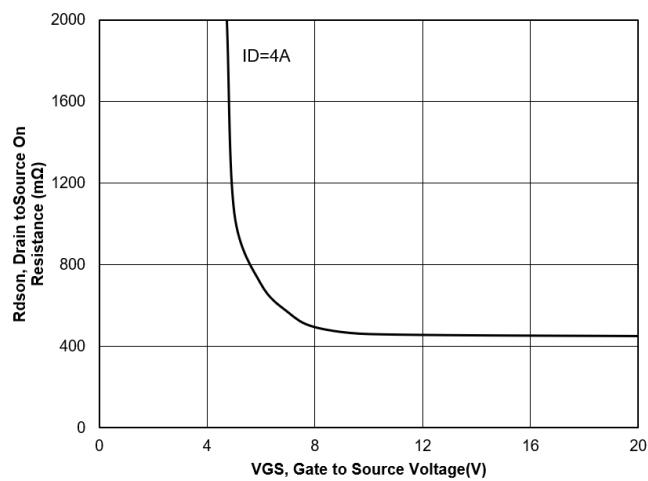


Figure 7. Typical Drain to Source ON Resistance

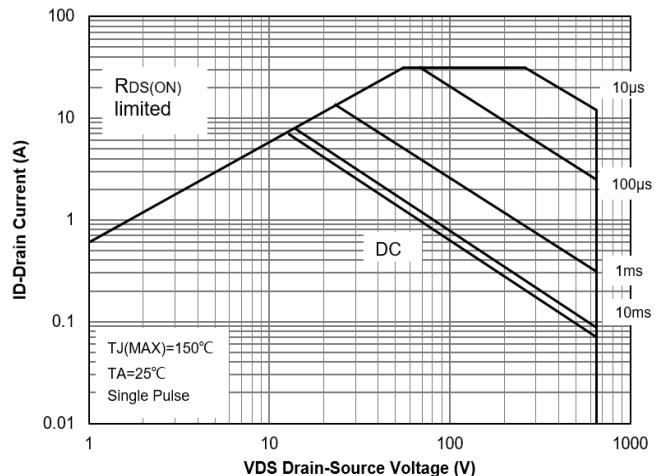


Figure 8. Safe Operation Area

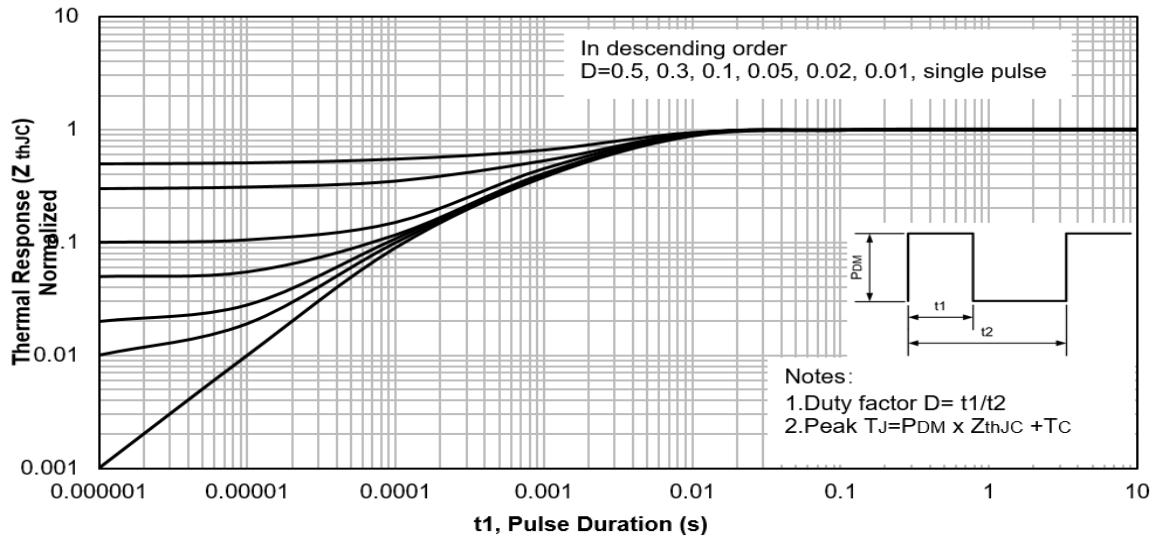


Figure 9. Maximum Effective Transient Thermal Impedance ,Junction-to-Case

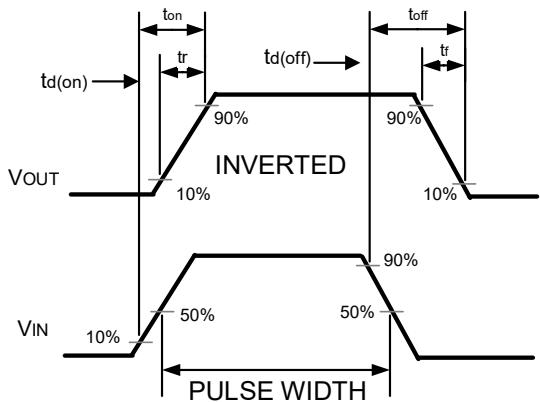
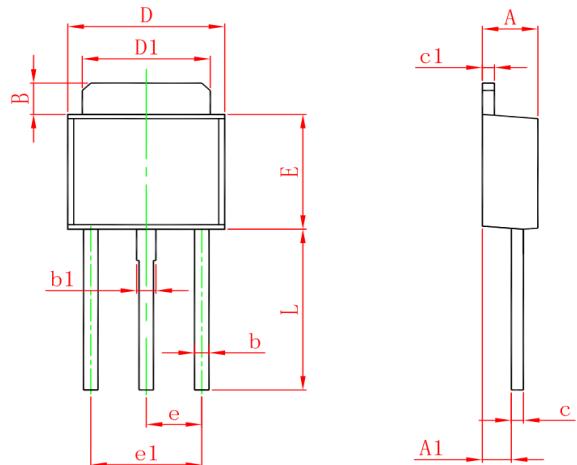


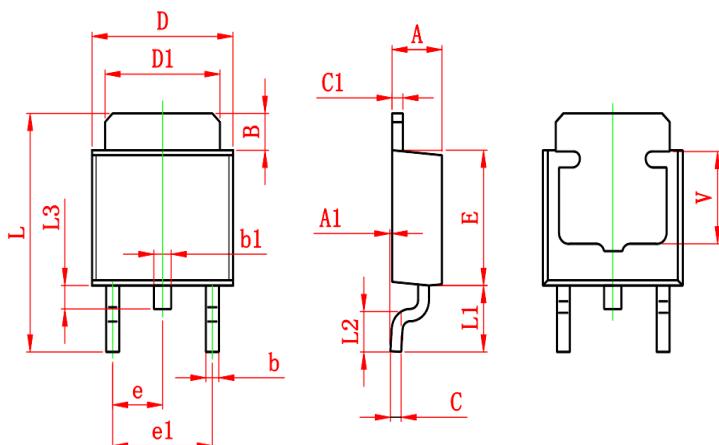
Figure 10. Switching wave

TO-251 Package Outline Drawing



Symbol	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	2.200	2.400	0.087	0.094
A1	1.050	1.350	0.042	0.054
B	1.350	1.650	0.053	0.065
b	0.500	0.700	0.020	0.028
b1	0.700	0.900	0.028	0.035
c	0.430	0.580	0.017	0.023
c1	0.430	0.580	0.017	0.023
D	6.350	6.650	0.250	0.262
D1	5.200	5.400	0.205	0.213
E	5.400	5.700	0.213	0.224
e	2.300 TYP.		0.091 TYP.	
e1	4.500	4.700	0.177	0.185
L	7.500	7.900	0.295	0.311

TO-252 Package Outline Drawing



Symbol	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
B	1.350	1.650	0.053	0.065
b	0.500	0.700	0.020	0.028
b1	0.700	0.900	0.028	0.035
c	0.430	0.580	0.017	0.023
c1	0.430	0.580	0.017	0.023
D	6.350	6.650	0.250	0.262
D1	5.200	5.400	0.205	0.213
E	5.400	5.700	0.213	0.224
e	2.300 TYP.		0.091 TYP.	
e1	4.500	4.700	0.177	0.185
L	9.500	9.900	0.374	0.390
L1	2.550	2.900	0.100	0.114
L2	1.400	1.780	0.055	0.070
L3	0.600	0.900	0.024	0.035
V	3.800 REF.		0.150 REF.	

Contact Information

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